

TE Internal #: 2483180-8

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, .8 mm [.031

in] Centerline, Header & Push-Push Assembly, Gold Flash, Surface

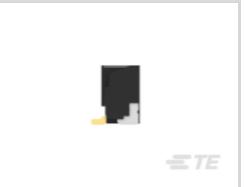
Mount

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Connectors > PCB Connectors > PCB Headers & Receptacles













PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Wire-to-Board

Number of Positions: 8

Number of Rows: 1

Features

Product Type Features

PCB Connector Type	PCB Mount Header
Connector System	Wire-to-Board
Header Type	Header & Push-Push Assembly
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly
Configuration Features	
Configuration Features PCB Mount Orientation	Vertical
	Vertical 8
PCB Mount Orientation	
PCB Mount Orientation Number of Positions	8

Gold Flash

Contact Features

Contact Mating Area Plating Material



Contact Type	Pin
Contact Current Rating (Max)	.5 A
Termination Features	
Termination Method to PCB	Surface Mount
Mechanical Attachment	
Mating Retention	With
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	Without
Housing Features	
Centerline (Pitch)	.8 mm[.031 in]
Usage Conditions	
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free

Reel/Carton

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Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts





Documents

Product Drawings

0.8mm Low-profile IDC Hdr Str WTB 8 Pos

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2483180-8_1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2483180-8_1.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2483180-8_1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of us

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, .8 mm [.031 in] Centerline, Header & Push-Push Assembly, Gold Flash, Surface Mount



Datasheets & Catalog Pages

0.8mm-Low-Profile-IDC-Flyer

English

Product Specifications

Product Specification

English